

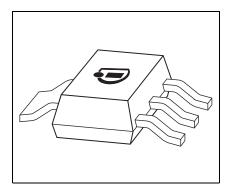
5-V Low Drop Fixed Voltage Regulator

TLE 4264-2



Features

- Output voltage tolerance $\leq \pm 3\%$ ($\pm 2\%$ up to 50 mA)
- 150 mA current capability
- Low-drop voltage
- Very low current consumption: 40 μA
- Overtemperature protection
- Short-circuit proof
- Suitable for use in automotive electronics
- Reverse polarity proof
- Green Product (RoHS compliant)
- AEC Qualified



Functional Description

The TLE 4264-2 is a monolithic integrated low-drop fixed voltage regulator which can supply loads up to 150 mA. It is functional compatible to the TLE 4264, but has a reduced quiescent current of typ. 40 μ A. The TLE 4264-2 is especially designed for all applications which require very low quiescent currents. The device is available in the small surface mounted PG-SOT223-4 package. The device is pin compatible to the TLE 4264. The regulator is designed to supply microprocessor systems under the severe condition of automotive applications and is therefore equipped with additional protection against overload, short-circuit and overtemperature. Of course the TLE 4264-2 can be used in all other applications, wherever a stabilized voltage is required.

An input voltage V_1 in the range of 5.5 V < V_1 < 45 V is regulated to $V_{Q,nom}$ = 5 V with an accuracy of ±3%. An accuracy of ±2% is kept for a load current range up to 50 mA.

The device operates in the temperature range of T_i = -40 to 150 °C.

Туре	Package
TLE 4264-2 G	PG-SOT223-4

Data Sheet



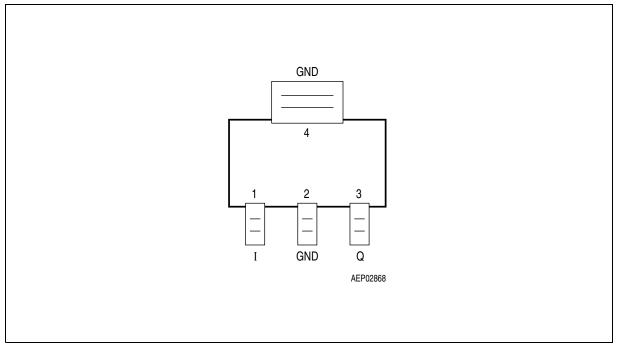


Figure 1 Pin Configuration (top view)

Pin	Symbol	Function
1	I	Input voltage; block to ground directly with a ceramic capacitor
2, 4	GND	Ground
3	Q	5-V output voltage; block to ground with a capacitor $C_Q \ge 10 \ \mu\text{F}$, ESR $\le 4 \ \Omega$



Circuit Description

The control amplifier compares a reference voltage, which is kept highly precise by resistance adjustment, to a voltage that is proportional to the output voltage and drives the base of the series transistor via a buffer. Saturation control, working as a function of load current, prevents any over-saturation of the power element. The IC is additionally protected against overload, overtemperature and reverse polarity.

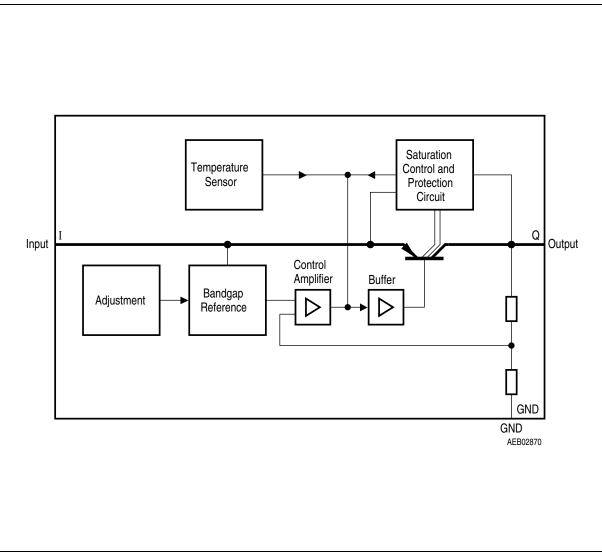


Figure 2 Block Diagram



Parameter	Symbol	Limit Values		Unit	Notes
		Min.	Max.		
Input I			I	1	
Input voltage	V_1	-42	45	V	-
Input current	I	_	-	-	limited internally
Output Q					·
Output voltage	VQ	-0.3	32	V	-
Output current	IQ	_	-	-	limited internally
Ground GND					·
Current	I _{GND}	50	_	mA	-
Temperatures					
Junction temperature	T _j	-	150	°C	-
Storage temperature	$T_{\rm stg}$	-50	150	°C	-
Thermal Resistances					
Junction-ambient	R _{thj-a}	_	164	K/W	PG-SOT223-4 ¹⁾
	R _{thj-a}	-	81	K/W	PG-SOT223-4, 300 mm ² heat sink area
Junction-pin	R _{thj-p}	-	17	K/W	PG-SOT223-4 ²⁾
Operating Range		1	1		
Input voltage	V_{I}	5.5	45	V	-
Junction temperature	T _j	-40	150	°C	_

Table 2Absolute Maximum Ratings

1) Package mounted on PCB $80 \times 80 \times 1.5$ mm³; 35μ Cu; 5μ Sn; Footprint only; zero airflow.

2) Measured to pin 4.



Table 3Characteristics

 $V_{\rm I}$ = 13.5 V; -40 °C \leq $T_{\rm j}$ \leq 125 °C, unless specified otherwise

Parameter	Symbol	Limit Values			Unit	Test Conditions
		Min.	Тур.	Max.		
Output voltage	V _Q	4.85	5.0	5.15	V	$5 \text{ mA} \le I_{\text{Q}} \le 100 \text{ mA}$ $6 \text{ V} \le V_{\text{I}} \le 21 \text{ V}$
Output voltage	V _Q	4.9	5.0	5.1	V	$\begin{array}{l} 5 \text{ mA} \leq I_{\text{Q}} \leq 50 \text{ mA} \\ 9 \text{ V} \leq V_{\text{I}} \leq 16 \text{ V} \end{array}$
Output-current limiting	I _Q	150	200	500	mA	_
Current consumption $I_q = I_l - I_Q$	Iq	-	40	60	μA	$I_{\rm Q} = 100 \ \mu {\rm A}, \ T_{\rm j} \le 85 \ ^{\circ}{ m C}$
		_	40	70	μA	$I_{\rm Q} = 100 \ \mu {\rm A},$
Current consumption $I_q = I_1 - I_Q$	Iq	-	1.7	4	mA	I _Q = 50 mA
Drop voltage	V_{dr}	-	0.22	0.5	V	$I_{\rm Q} = 100 {\rm mA^{1)}}$
Load regulation	$\Delta V_{ m Q, \ lo}$	-	50	90	mV	$I_{\rm Q}$ = 1 to 100 mA $V_{\rm I}$ = 13.5 V
Line regulation	$\Delta V_{Q, li}$	-	5	30	mV	$V_{\rm I}$ = 6 to 28 V $I_{\rm Q}$ = 1 mA
Power Supply Ripple Rejection	PSRR	_	68	-	dB	$f_{\rm r}$ = 100 Hz $V_{\rm r}$ = 0.5 Vpp
Output Capacitor	C _Q	10	-	-	μF	ESR \leq 4 Ω at 10 kHz

1) Drop voltage = $V_{\rm I}$ - $V_{\rm Q}$ (measured where $V_{\rm Q}$ has dropped 100 mV from the nominal value obtained at $V_{\rm I}$ = 13.5 V)



Application Information

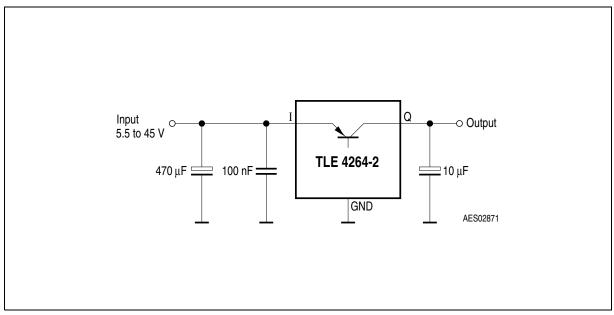


Figure 3 Application Circuit

In the TLE 4264-2 the output voltage is divided and compared to an internal reference of 2.5 V typical. The regulation loop controls the output to achieve an output voltage of 5 V with an accuracy of $\pm 3\%$ at an input voltage range of 5.5 V < V_1 < 45 V.

Figure 4 shows a typical application circuit. For stability of the control loop the TLE 4264-2 output requires an output capacitor C_Q of at least 10 μ F with a maximum permissible ESR of 4 Ω . Tantalum as well as multi layer ceramic capacitors are suitable.

At the input of the regulator an input capacitor is necessary for compensating line influences (100 nF ceramic capacitor recommended). A resistor of approx. 1 Ω in series with $C_{\rm l}$, can damp any oscillation occurring due the input inductivity and the input capacitor.

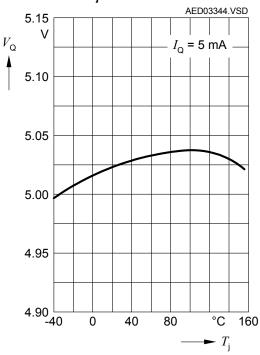
In the application circuit shown in **Figure 4** an additional electrolytic input capacitor of 470 μ F is added in order to buffer supply line influences. This capacitor is recommended, if the device is sourced via long supply lines of several meters.

The TLE 4264-2 can supply up to 150 mA. However for protection for high input voltage above 25 V, the output current is reduced (SOA protection).

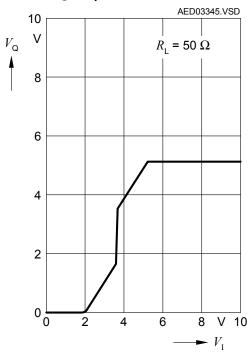


Typical Performance Characteristics

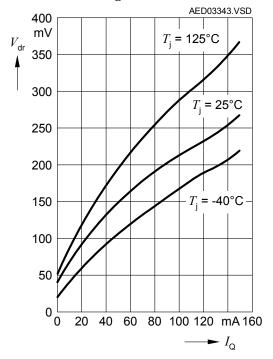
Output Voltage V_{Q} versus Temperature T_{i}



Output Voltage $V_{\rm Q}$ versus Input Voltage $V_{\rm I}$

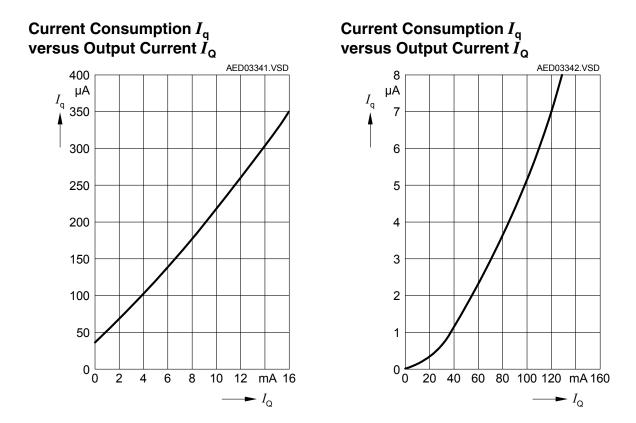


Drop Voltage $V_{\rm dr}$ versus Output Current $I_{\rm Q}$



Data Sheet







Package Outlines

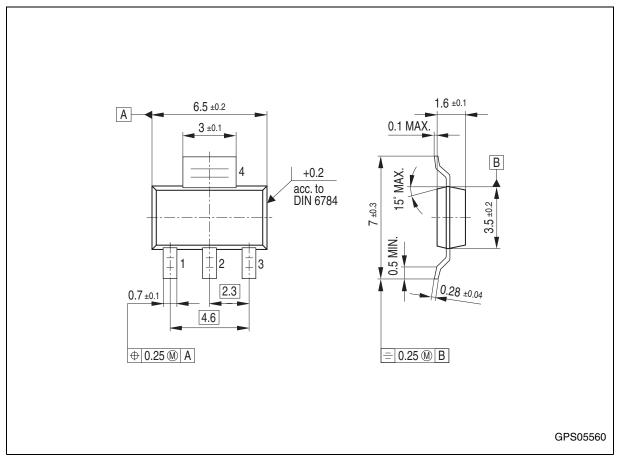


Figure 4 PG-SOT223-4 (Plastic Small Outline Transistor)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.

SMD = Surface Mounted Device

Data Sheet

Dimensions in mm



Revision History

Version	Date	Changes
Rev. 2.6	2008-03-10	Simplified package name to PG-SOT223-4. No modification of released product.
Rev. 2.5	2007-03-20	Initial version of RoHS-compliant derivate of TLE 4264-2 Page 1: AEC certified statement added Page 1 and Page 9: RoHS compliance statement and Green product feature added Page 1 and Page 9: Package changed to RoHS compliant version Legal Disclaimer updated

Edition 2008-03-10 Published by Infineon Technologies AG 81726 Munich, Germany © 2008 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.